

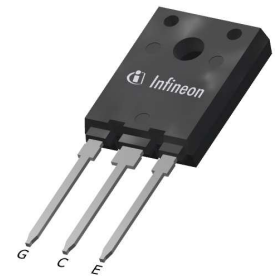
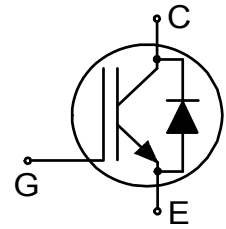
## TRENCHSTOP™ Advanced Isolation

High speed switching series third generation IGBT copacked with Rapid 1 fast and soft antiparallel diode in fully isolated package

**Features:**

TRENCHSTOP™ technology offers :

- LOW  $V_{CE(sat)}$
- Short circuit withstand time  $5\mu s$  at  $T_{vj} = 175^{\circ}C$
- Positive temperature coefficient in  $V_{CE(sat)}$
- Low EMI
- Very soft, fast recovery anti-parallel diode
- Maximum junction temperature  $175^{\circ}C$
- 2500  $V_{RMS}$  electrical isolation, 50/60 Hz,  $t = 1$  min
- 100 % tested isolated mounting surface
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <http://www.infineon.com/igbt>



Fully isolated package TO-247

**Potential Applications:**

- General Purpose Drives (GPD)
- Servo Drives
- Industrial SMPS
- Industrial UPS
- Charger
- Welding
- Solar String Inverter

**Product Validation:**

Qualified for industrial applications according to the relevant tests of JEDEC 47/20/22

**Key Performance and Package Parameters**

| Type         | $V_{CE}$ | $I_C$ | $V_{CEsat}, T_{vj}=25^{\circ}C$ | $T_{vjmax}$    | Marking | Package       |
|--------------|----------|-------|---------------------------------|----------------|---------|---------------|
| IKFW60N60EH3 | 600V     | 50A   | 1.85V                           | $175^{\circ}C$ | K60DEH3 | PG-TO247-3-AI |

## Table of Contents

|   |    |
|---|----|
| Description .....                         | 1  |
| Table of Contents .....                   | 2  |
| Maximum Ratings .....                     | 3  |
| Thermal Resistance .....                  | 3  |
| Electrical Characteristics .....          | 4  |
| Electrical Characteristics Diagrams ..... | 6  |
| Package Drawing .....                     | 13 |
| Testing Conditions .....                  | 14 |
| Revision History .....                    | 15 |
| Disclaimer .....                          | 16 |

## TRENCHSTOP™ Advanced Isolation

## Maximum Ratings

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

| Parameter   | Symbol      | Value                              | Unit               |
|---|-------------|------------------------------------|--------------------|
| Collector-emitter voltage, $T_{vj} \geq 25^{\circ}\text{C}$   | $V_{CE}$    | 600                                | V                  |
| DC collector current, limited by $T_{vjmax}$<br>$T_h = 25^{\circ}\text{C}$<br>$T_h = 65^{\circ}\text{C}$<br>$T_h = 65^{\circ}\text{C}$  | $I_C$       | 64.0<br>52.0<br>63.0 <sup>1)</sup> | A                  |
| Pulsed collector current, $t_p$ limited by $T_{vjmax}$  | $I_{Cpuls}$ | 200.0                              | A                  |
| Turn off safe operating area<br>$V_{CE} \leq 600\text{V}$ , $T_{vj} \leq 175^{\circ}\text{C}$ , $t_p = 1\mu\text{s}$  | -           | 200.0                              | A                  |
| Diode forward current, limited by $T_{vjmax}$<br>$T_h = 25^{\circ}\text{C}$<br>$T_h = 65^{\circ}\text{C}$   | $I_F$       | 80.0<br>60.0                       | A                  |
| Diode pulsed current, $t_p$ limited by $T_{vjmax}$  | $I_{Fpuls}$ | 200.0                              | A                  |
| Gate-emitter voltage<br>Transient Gate-emitter voltage ( $t_p \leq 10\mu\text{s}$ , $D < 0.010$ )   | $V_{GE}$    | $\pm 20$<br>$\pm 30$               | V                  |
| Short circuit withstand time<br>$V_{GE} = 15.0\text{V}$ , $V_{CC} \leq 400\text{V}$<br>Allowed number of short circuits < 1000<br>Time between short circuits: $\geq 1.0\text{s}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $t_{SC}$    | 5                                  | $\mu\text{s}$      |
| Power dissipation $T_h = 25^{\circ}\text{C}$<br>Power dissipation $T_h = 65^{\circ}\text{C}$  | $P_{tot}$   | 164.0<br>120.0                     | W                  |
| Operating junction temperature  | $T_{vj}$    | -40...+175                         | $^{\circ}\text{C}$ |
| Storage temperature   | $T_{stg}$   | -55...+150                         | $^{\circ}\text{C}$ |
| Soldering temperature,<br>wave soldering 1.6mm (0.063in.) from case for 10s   |             | 260                                | $^{\circ}\text{C}$ |
| Mounting torque, M3 screw<br>Maximum of mounting processes: 3   | $M$         | 0.6                                | Nm                 |
| Isolation voltage RMS, $f = 50/60\text{Hz}$ , $t = 1\text{min}^{2)}$  | $V_{isol}$  | 2500                               | V                  |

## Thermal Resistance

| Parameter  | Symbol        | Conditions | Value |      |      | Unit |
|--|---------------|------------|-------|------|------|------|
|  |               |            | min.  | typ. | max. |      |
| <b>R<sub>th</sub> Characteristics</b>                          |               |            |       |      |      |      |
| IGBT thermal resistance, <sup>3)</sup><br>junction - heatsink  | $R_{th(j-h)}$ |            | -     | 0.77 | 0.91 | K/W  |
| Diode thermal resistance, <sup>3)</sup><br>junction - heatsink | $R_{th(j-h)}$ |            | -     | 1.18 | 1.30 | K/W  |
| Thermal resistance<br>junction - ambient                       | $R_{th(j-a)}$ |            | -     | -    | 65   | K/W  |

<sup>1)</sup> Equivalent current rating in TO-247-3 at  $T_h = 65^{\circ}\text{C}$  using reference insulation material: 152 $\mu\text{m}$ , 1.3 W/mK, standard polyimide based reinforced carrier insulator

<sup>2)</sup> For a proper handling and assembly of the advanced isolation device in the application refer to the note at the package drawing.

<sup>3)</sup> At force on body  $F = 500\text{N}$ ,  $T_a = 25^{\circ}\text{C}$

## TRENCHSTOP™ Advanced Isolation

Electrical Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$ , unless otherwise specified

| Parameter                            | Symbol        | Conditions   | Value  |              |           | Unit          |
|--------------------------------------|---------------|--|--------|--------------|-----------|---------------|
|                                      |               |  | min.   | typ.         | max.      |               |
| <b>Static Characteristic</b>         |               |  |        |              |           |               |
| Collector-emitter breakdown voltage  | $V_{(BR)CES}$ | $V_{GE} = 0\text{V}, I_C = 0.50\text{mA}$  | 600    | -            | -         | V             |
| Collector-emitter saturation voltage | $V_{CEsat}$   | $V_{GE} = 15.0\text{V}, I_C = 50.0\text{A}$<br>$T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 175^{\circ}\text{C}$ | -<br>- | 1.85<br>2.25 | 2.30<br>- | V             |
| Diode forward voltage                | $V_F$         | $V_{GE} = 0\text{V}, I_F = 50.0\text{A}$<br>$T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 175^{\circ}\text{C}$    | -<br>- | 1.45<br>1.40 | 1.75<br>- | V             |
| Gate-emitter threshold voltage       | $V_{GE(th)}$  | $I_C = 0.80\text{mA}, V_{CE} = V_{GE}$   | 4.1    | 5.1          | 5.7       | V             |
| Zero gate voltage collector current  | $I_{CES}$     | $V_{CE} = 600\text{V}, V_{GE} = 0\text{V}$<br>$T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 175^{\circ}\text{C}$  | -<br>- | -<br>880     | 40<br>-   | $\mu\text{A}$ |
| Gate-emitter leakage current         | $I_{GES}$     | $V_{CE} = 0\text{V}, V_{GE} = 20\text{V}$  | -      | -            | 100       | nA            |
| Transconductance                     | $g_{fs}$      | $V_{CE} = 20\text{V}, I_C = 50.0\text{A}$  | -      | 25.0         | -         | S             |

Electrical Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$ , unless otherwise specified

| Parameter  | Symbol      | Conditions  | Value |       |      | Unit |
|--|-------------|---|-------|-------|------|------|
|  |             |   | min.  | typ.  | max. |      |
| <b>Dynamic Characteristic</b>  |             |   |       |       |      |      |
| Input capacitance  | $C_{ies}$   | $V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$  | -     | 3216  | -    | pF   |
| Output capacitance   | $C_{oes}$   |   | -     | 150   | -    |      |
| Reverse transfer capacitance   | $C_{res}$   |   | -     | 90    | -    |      |
| Gate charge  | $Q_G$       | $V_{CC} = 480\text{V}, I_C = 50.0\text{A},$<br>$V_{GE} = 15\text{V}$  | -     | 290.0 | -    | nC   |
| Internal emitter inductance<br>measured 5mm (0.197 in.) from<br>case   | $L_E$       |   | -     | 13.0  | -    | nH   |
| Short circuit collector current<br>Max. 1000 short circuits<br>Time between short circuits: $\geq 1.0\text{s}$ | $I_{C(SC)}$ | $V_{GE} = 15.0\text{V}, V_{CC} \leq 400\text{V},$<br>$t_{SC} \leq 5\mu\text{s}$<br>$T_{vj} = 150^{\circ}\text{C}$ | -     | 330   | -    | A    |

## Switching Characteristic, Inductive Load

| Parameter   | Symbol       | Conditions   | Value |      |      | Unit |
|---|--------------|--|-------|------|------|------|
|   |              |  | min.  | typ. | max. |      |
| <b>IGBT Characteristic, at <math>T_{vj} = 25^{\circ}\text{C}</math></b> |              |  |       |      |      |      |
| Turn-on delay time  | $t_{d(on)}$  | $T_{vj} = 25^{\circ}\text{C},$<br>$V_{CC} = 400\text{V}, I_C = 50.0\text{A},$<br>$V_{GE} = 0.0/15.0\text{V},$<br>$R_{G(on)} = 7.0\Omega, R_{G(off)} = 7.0\Omega,$<br>$L\sigma = 75\text{nH}, C\sigma = 30\text{pF}$<br>$L\sigma, C\sigma$ from Fig. E<br>Energy losses include "tail" and<br>diode reverse recovery. | -     | 27   | -    | ns   |
| Rise time   | $t_r$        |  | -     | 37   | -    | ns   |
| Turn-off delay time   | $t_{d(off)}$ |  | -     | 229  | -    | ns   |
| Fall time   | $t_f$        |  | -     | 24   | -    | ns   |
| Turn-on energy  | $E_{on}$     |  | -     | 1.74 | -    | mJ   |
| Turn-off energy   | $E_{off}$    |  | -     | 0.93 | -    | mJ   |
| Total switching energy  | $E_{ts}$     |  | -     | 2.67 | -    | mJ   |

## TRENCHSTOP™ Advanced Isolation

Diode Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$ 

|  |              |  |   |       |   |                        |
|--|--------------|--|---|-------|---|------------------------|
| Diode reverse recovery time                                      | $t_{rr}$     | $T_{vj} = 25^{\circ}\text{C}$ ,<br>$V_R = 400\text{V}$ ,<br>$I_F = 50.0\text{A}$ ,<br>$di_F/dt = 1000\text{A}/\mu\text{s}$ | - | 91    | - | ns                     |
| Diode reverse recovery charge                                    | $Q_{rr}$     |  | - | 1.24  | - | $\mu\text{C}$          |
| Diode peak reverse recovery current                              | $I_{rrm}$    |  | - | 27.0  | - | A                      |
| Diode peak rate of fall of reverse recovery current during $t_b$ | $di_{rr}/dt$ |  | - | -1955 | - | $\text{A}/\mu\text{s}$ |

## Switching Characteristic, Inductive Load

| Parameter | Symbol | Conditions | Value |      |      | Unit |
|-----------|--------|------------|-------|------|------|------|
|           |        |            | min.  | typ. | max. |      |

IGBT Characteristic, at  $T_{vj} = 175^{\circ}\text{C}$ 

|                        |              |  |   |      |   |    |
|------------------------|--------------|--|---|------|---|----|
| Turn-on delay time     | $t_{d(on)}$  | $T_{vj} = 175^{\circ}\text{C}$ ,<br>$V_{CC} = 400\text{V}$ , $I_C = 50.0\text{A}$ ,<br>$V_{GE} = 0.0/15.0\text{V}$ ,<br>$R_{G(on)} = 7.0\Omega$ , $R_{G(off)} = 7.0\Omega$ ,<br>$L\sigma = 75\text{nH}$ , $C\sigma = 30\text{pF}$<br>$L\sigma$ , $C\sigma$ from Fig. E<br>Energy losses include "tail" and diode reverse recovery. | - | 26   | - | ns |
| Rise time              | $t_r$        |  | - | 37   | - | ns |
| Turn-off delay time    | $t_{d(off)}$ |  | - | 260  | - | ns |
| Fall time              | $t_f$        |  | - | 22   | - | ns |
| Turn-on energy         | $E_{on}$     |  | - | 2.60 | - | mJ |
| Turn-off energy        | $E_{off}$    |  | - | 1.02 | - | mJ |
| Total switching energy | $E_{ts}$     |  | - | 3.62 | - | mJ |

Diode Characteristic, at  $T_{vj} = 175^{\circ}\text{C}$ 

|  |              |   |   |       |   |                        |
|--|--------------|---|---|-------|---|------------------------|
| Diode reverse recovery time                                      | $t_{rr}$     | $T_{vj} = 175^{\circ}\text{C}$ ,<br>$V_R = 400\text{V}$ ,<br>$I_F = 50.0\text{A}$ ,<br>$di_F/dt = 1000\text{A}/\mu\text{s}$ | - | 139   | - | ns                     |
| Diode reverse recovery charge                                    | $Q_{rr}$     |   | - | 3.29  | - | $\mu\text{C}$          |
| Diode peak reverse recovery current                              | $I_{rrm}$    |   | - | 34.0  | - | A                      |
| Diode peak rate of fall of reverse recovery current during $t_b$ | $di_{rr}/dt$ |   | - | -1489 | - | $\text{A}/\mu\text{s}$ |

TRENCHSTOP™ Advanced Isolation

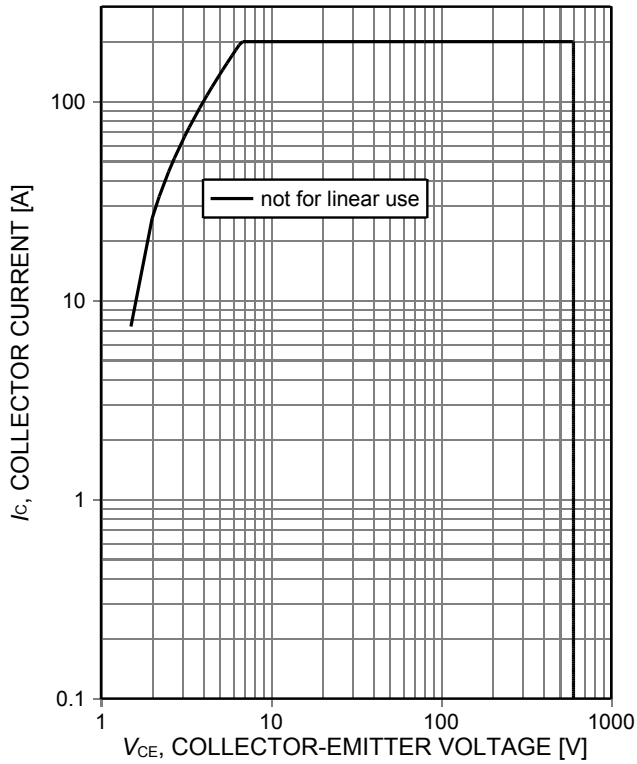


Figure 1. **Forward bias safe operating area**  
 ( $D=0$ ,  $T_h=25^\circ\text{C}$ ,  $T_j\leq 175^\circ\text{C}$ ,  $V_{GE}=15\text{V}$ ,  $t_p\leq 1\mu\text{s}$ )

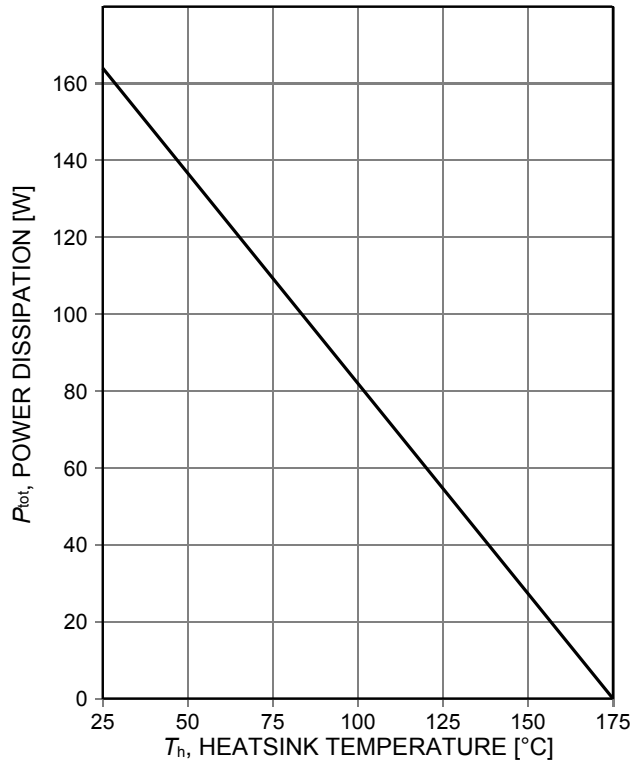


Figure 2. **Power dissipation as a function of heatsink temperature**  
 ( $T_j\leq 175^\circ\text{C}$ )

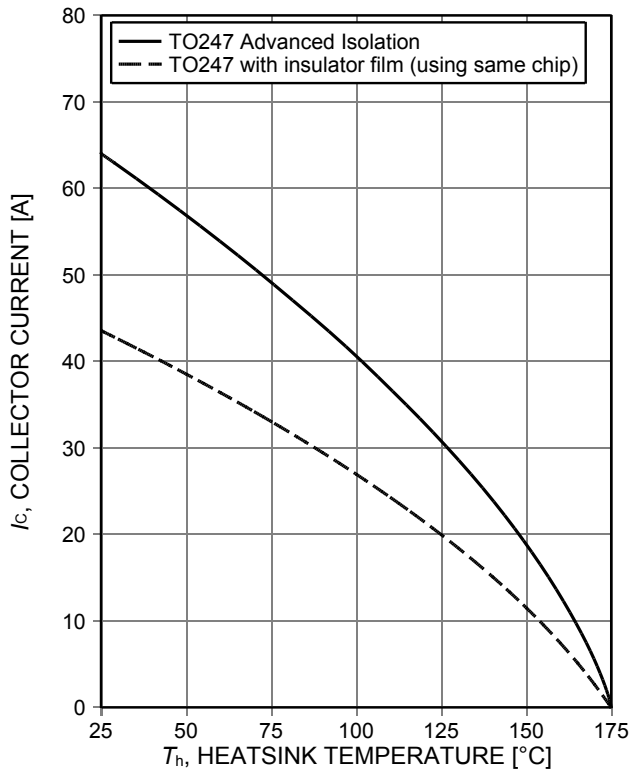


Figure 3. **Collector current as a function of heatsink temperature**  
 ( $V_{GE}\geq 15\text{V}$ ,  $T_j\leq 175^\circ\text{C}$ , insulator film: 152 $\mu\text{m}$ , 1.3W/mK)

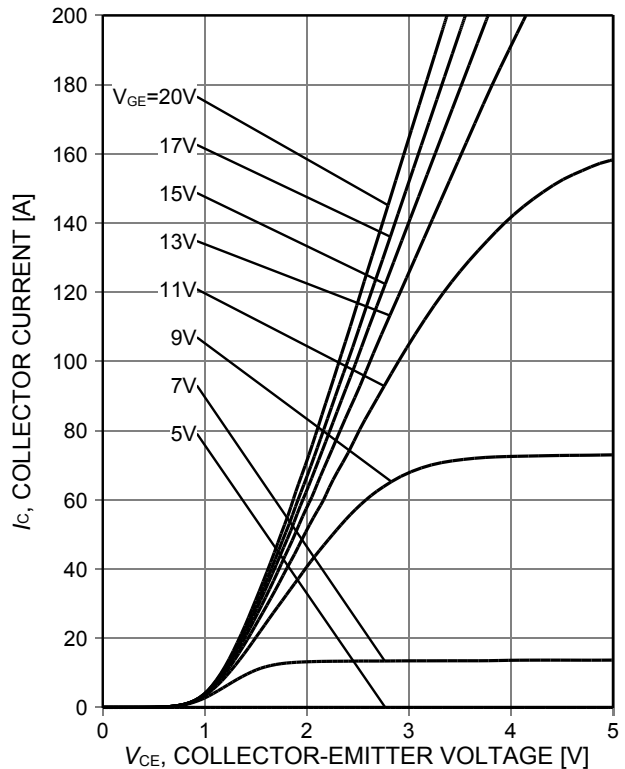


Figure 4. **Typical output characteristic**  
 ( $T_j=25^\circ\text{C}$ )

TRENCHSTOP™ Advanced Isolation

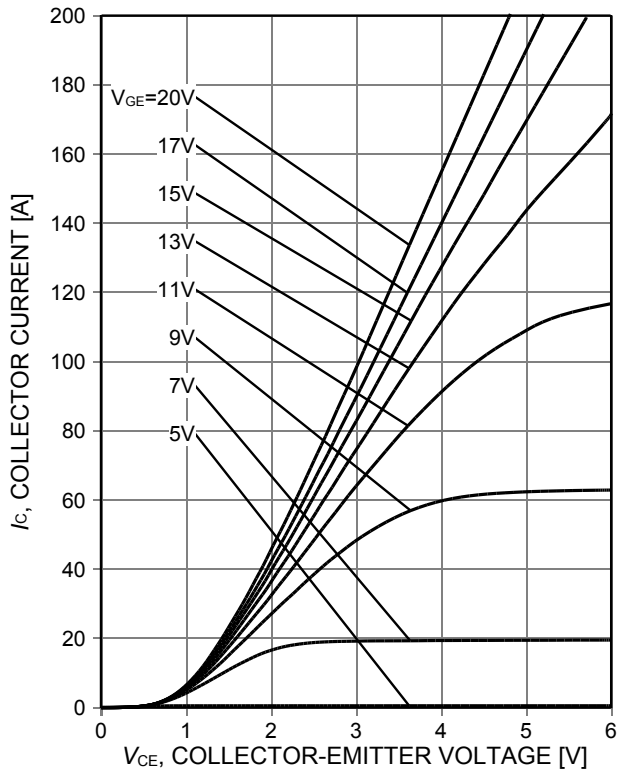


Figure 5. Typical output characteristic ( $T_j=175^\circ\text{C}$ )

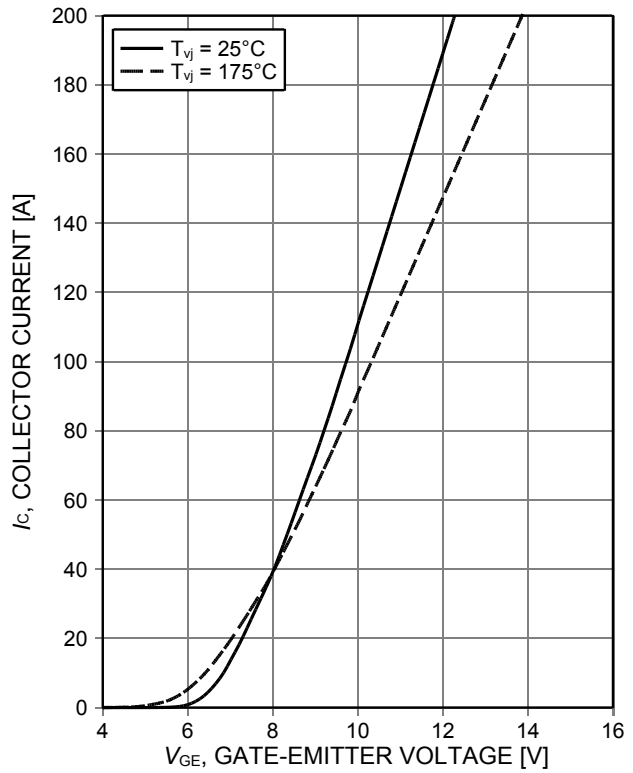


Figure 6. Typical transfer characteristic ( $V_{CE}=20\text{V}$ )

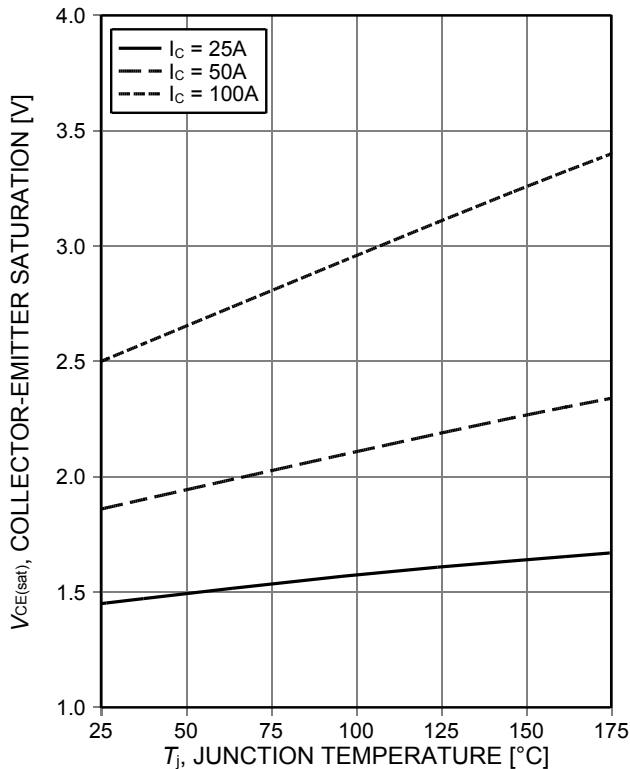


Figure 7. Typical collector-emitter saturation voltage as a function of junction temperature ( $V_{GE}=15\text{V}$ )

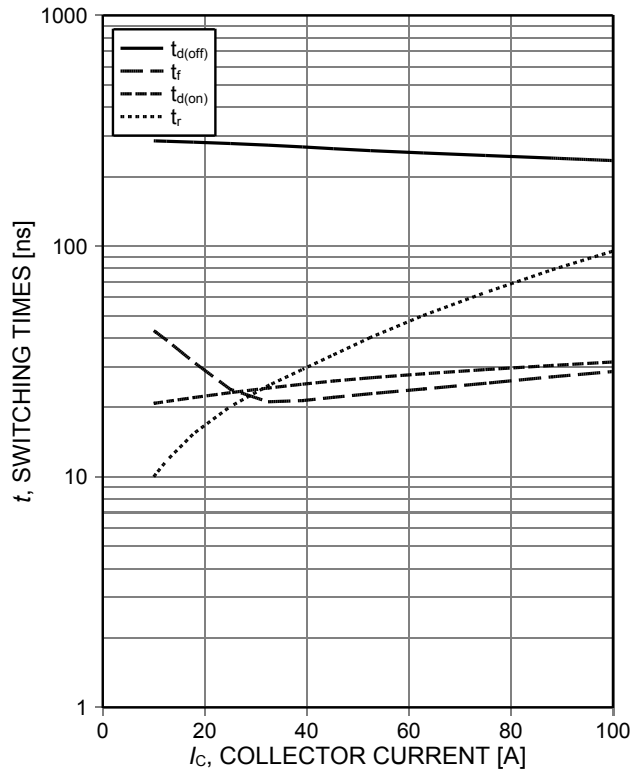


Figure 8. Typical switching times as a function of collector current (ind. load,  $T_j=175^\circ\text{C}$ ,  $V_{CE}=400\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $R_G=7\Omega$ , test circuit in Fig. E)

TRENCHSTOP™ Advanced Isolation

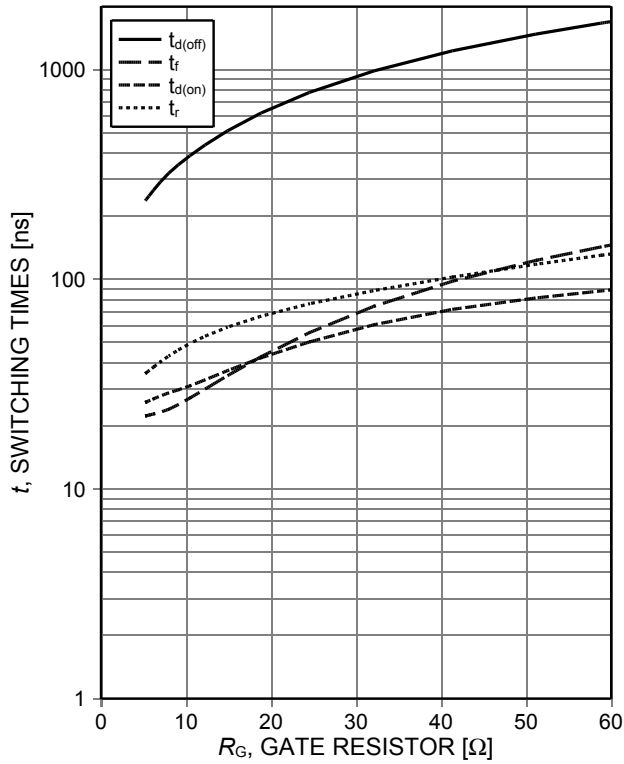


Figure 9. Typical switching times as a function of gate resistor (ind. load,  $T_j=175^\circ\text{C}$ ,  $V_{CE}=400\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=50\text{A}$ , test circuit in Fig. E)

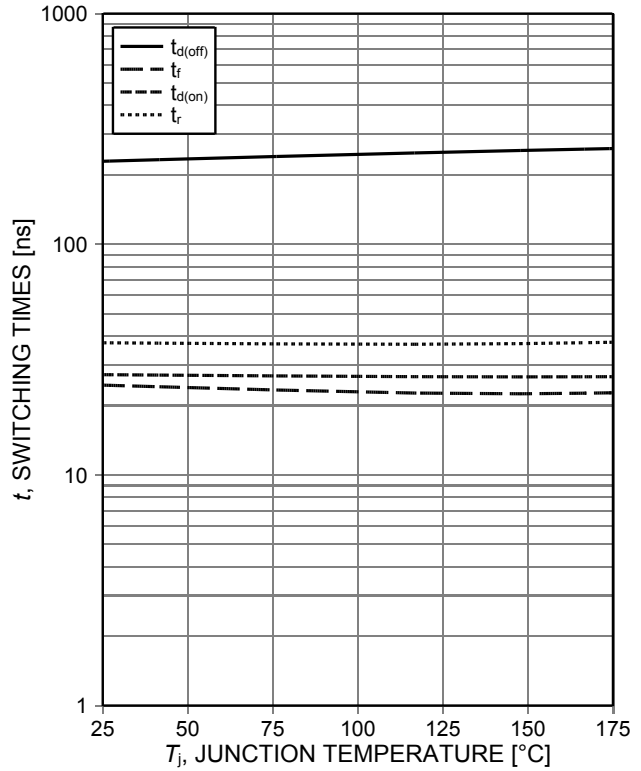


Figure 10. Typical switching times as a function of junction temperature (ind. load,  $V_{CE}=400\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=50\text{A}$ ,  $r_G=7\Omega$ , test circuit in Fig. E)

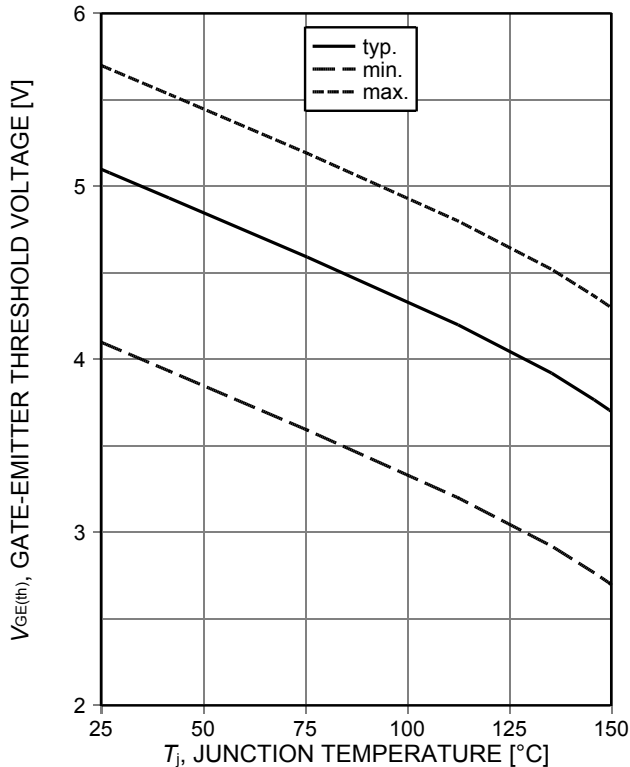


Figure 11. Gate-emitter threshold voltage as a function of junction temperature ( $I_C=0.43\text{mA}$ )

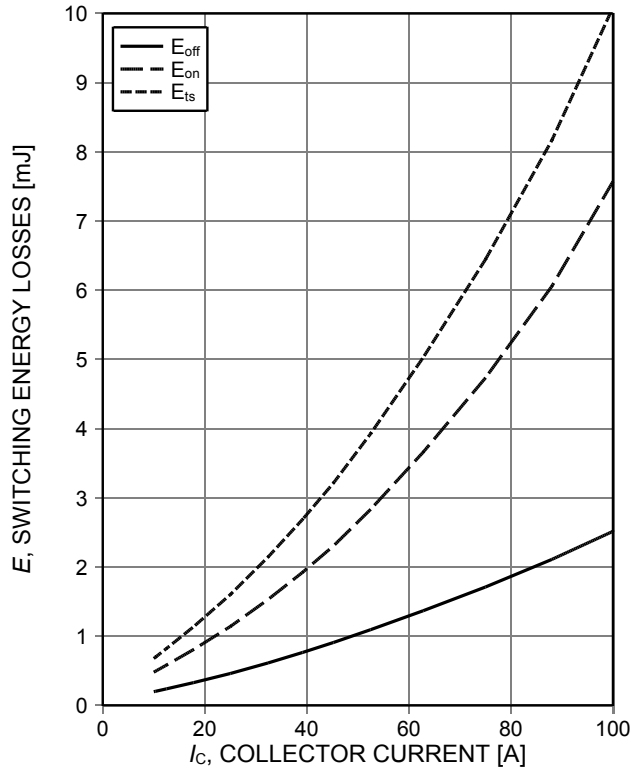


Figure 12. Typical switching energy losses as a function of collector current (ind. load,  $T_j=175^\circ\text{C}$ ,  $V_{CE}=400\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $R_G=7\Omega$ , test circuit in Fig. E)



TRENCHSTOP™ Advanced Isolation

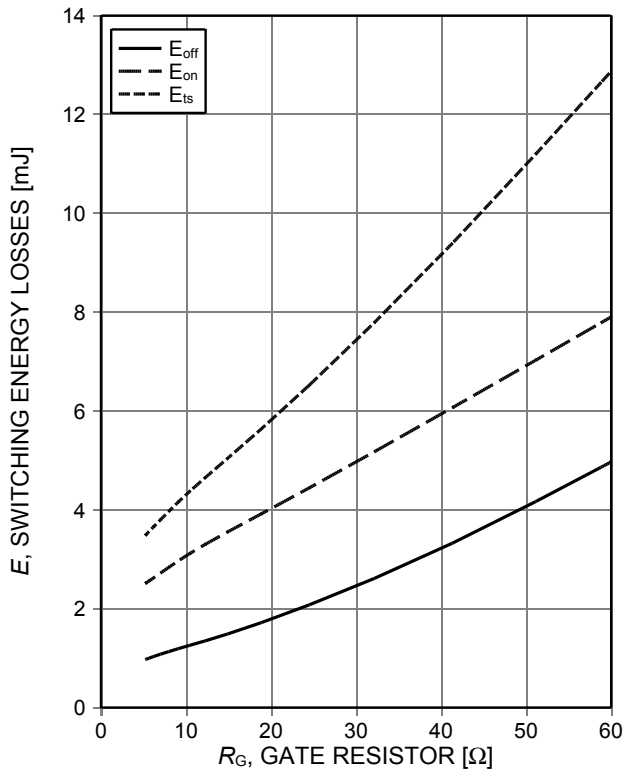


Figure 13. **Typical switching energy losses as a function of gate resistor**  
 (ind. load,  $T_j=175^\circ\text{C}$ ,  $V_{CE}=400\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=50\text{A}$ , test circuit in Fig. E)

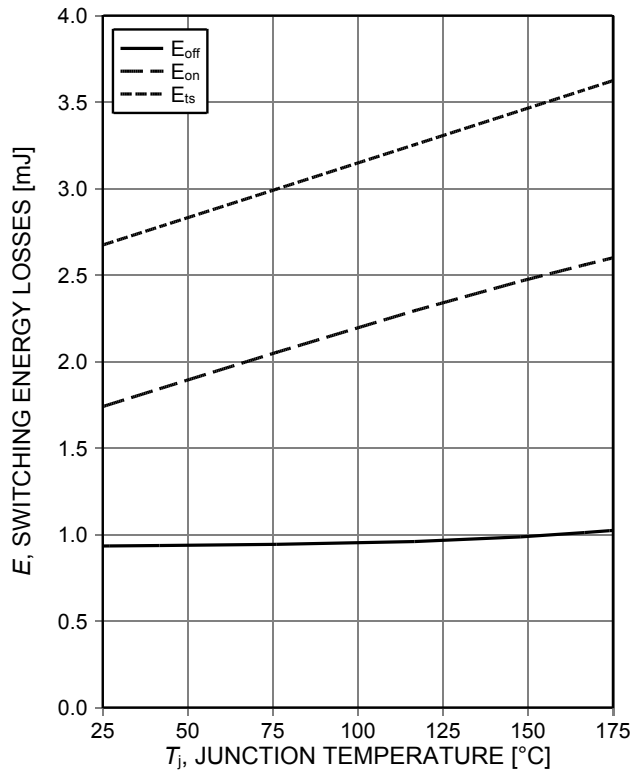


Figure 14. **Typical switching energy losses as a function of junction temperature**  
 (ind load,  $V_{CE}=400\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=50\text{A}$ ,  $R_G=7\Omega$ , test circuit in Fig. E)

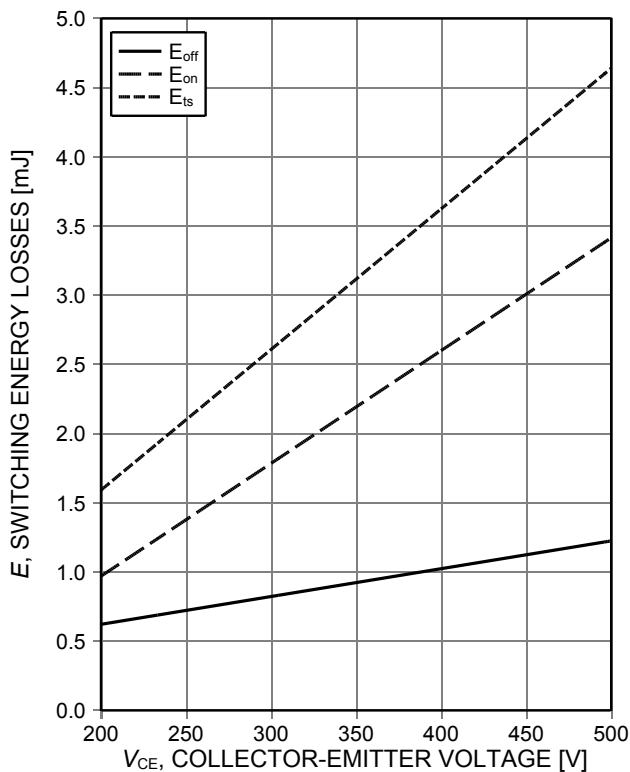


Figure 15. **Typical switching energy losses as a function of collector emitter voltage**  
 (ind. load,  $T_j=175^\circ\text{C}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=50\text{A}$ ,  $R_G=7\Omega$ , test circuit in Fig. E)

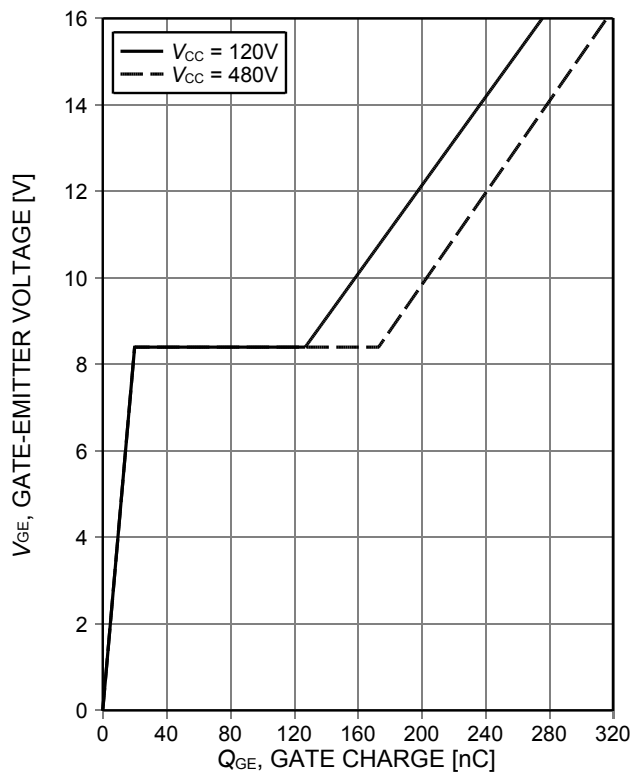


Figure 16. **Typical gate charge**  
 ( $I_C=50\text{A}$ )

TRENCHSTOP™ Advanced Isolation

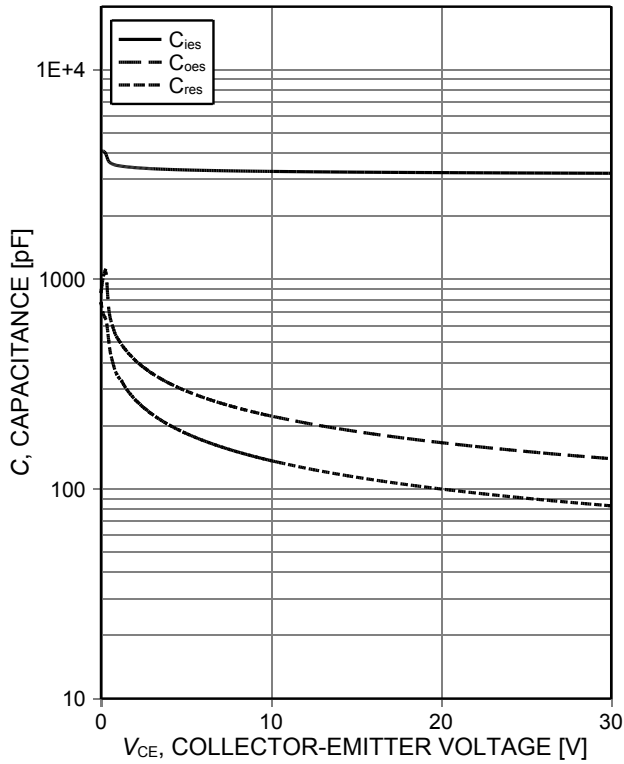


Figure 17. Typical capacitance as a function of collector-emitter voltage ( $V_{GE}=0V$ ,  $f=1MHz$ )

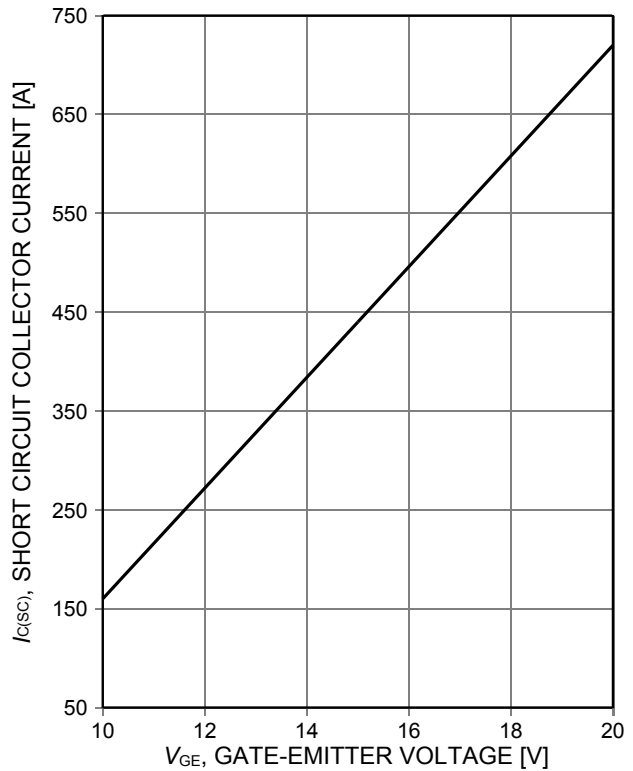


Figure 18. Typical short circuit collector current as a function of gate-emitter voltage ( $V_{CE}\leq 400V$ , start at  $T_j=25^\circ C$ )

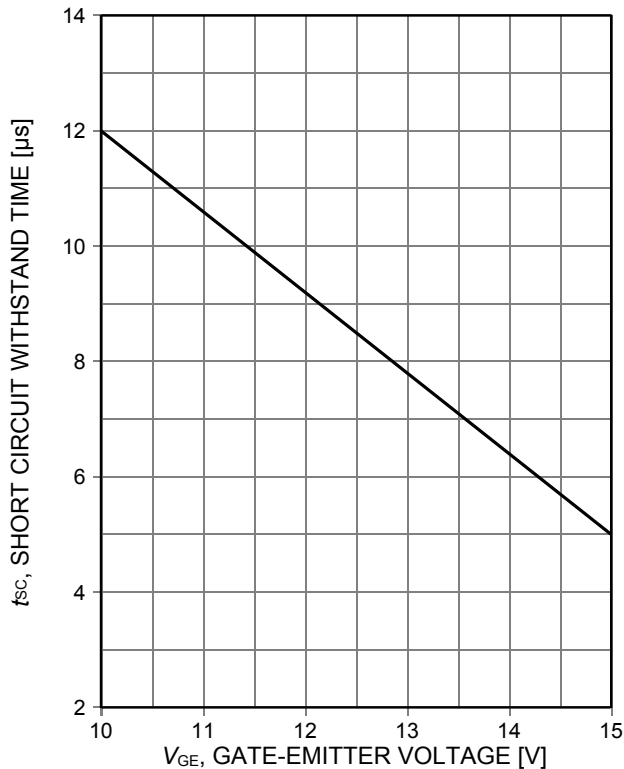


Figure 19. Short circuit withstand time as a function of gate-emitter voltage ( $V_{CE}\leq 400V$ , start at  $T_j\leq 150^\circ C$ )

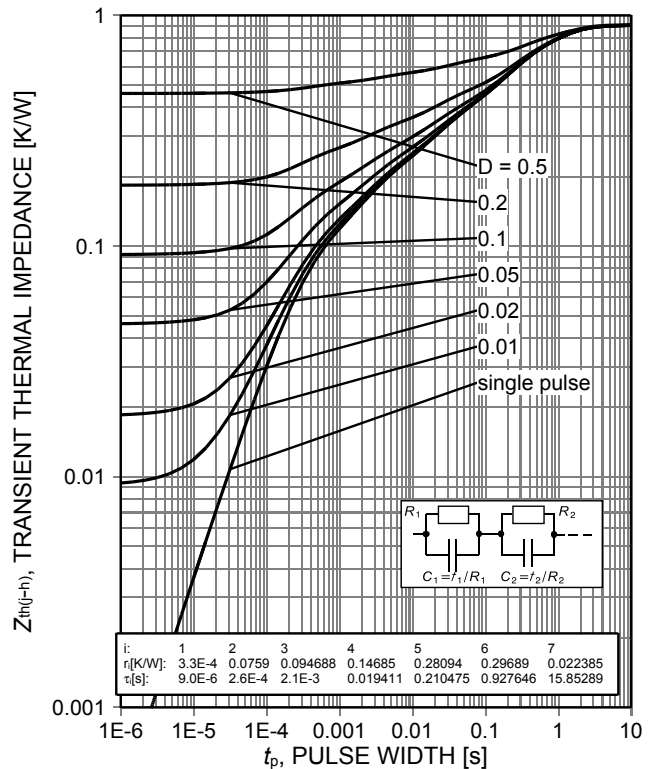


Figure 20. IGBT transient thermal impedance as a function of pulse width ( $D=t_p/T$ )

TRENCHSTOP™ Advanced Isolation

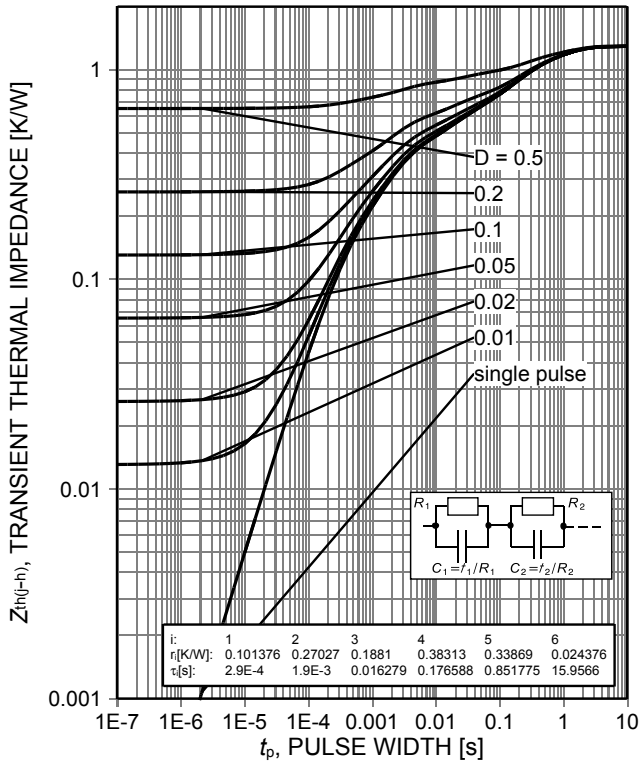


Figure 21. Diode transient thermal impedance as a function of pulse width ( $D=t_p/T$ )

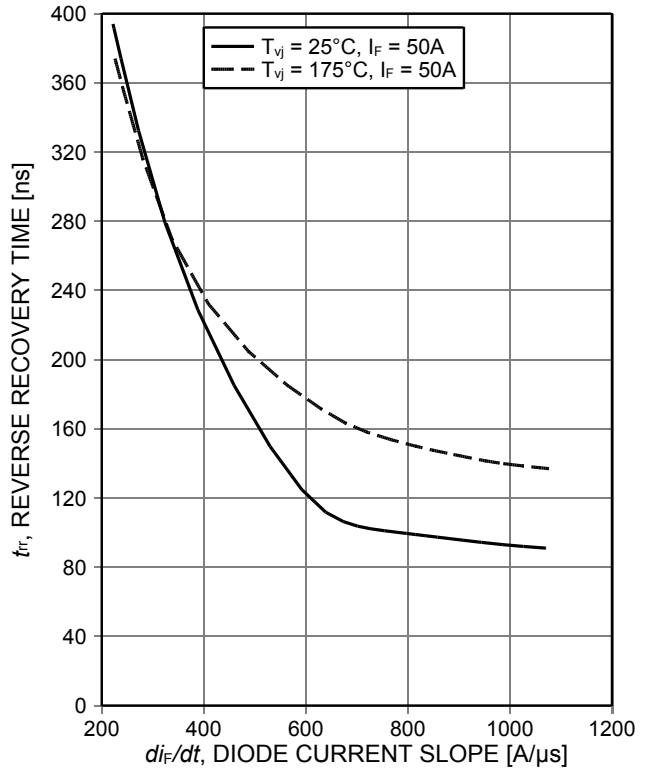


Figure 22. Typical reverse recovery time as a function of diode current slope ( $V_R=400V$ )

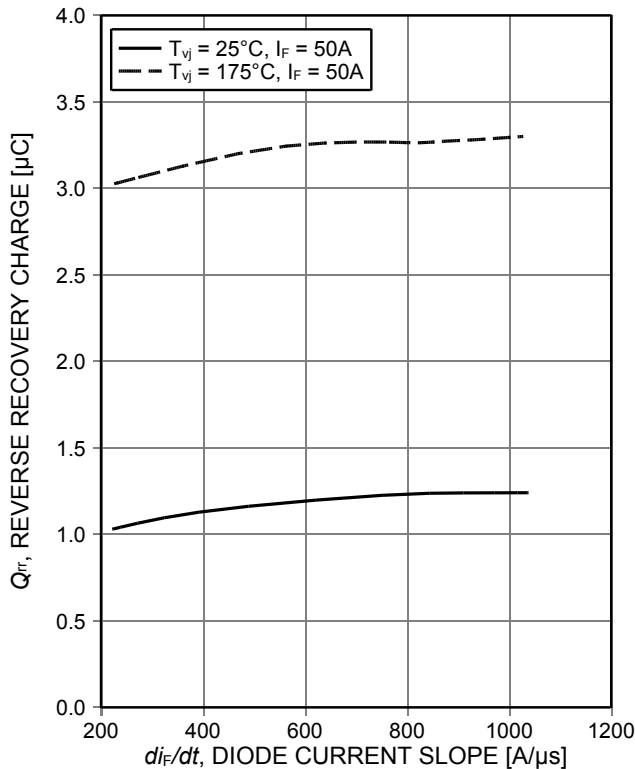


Figure 23. Typical reverse recovery charge as a function of diode current slope ( $V_R=400V$ )

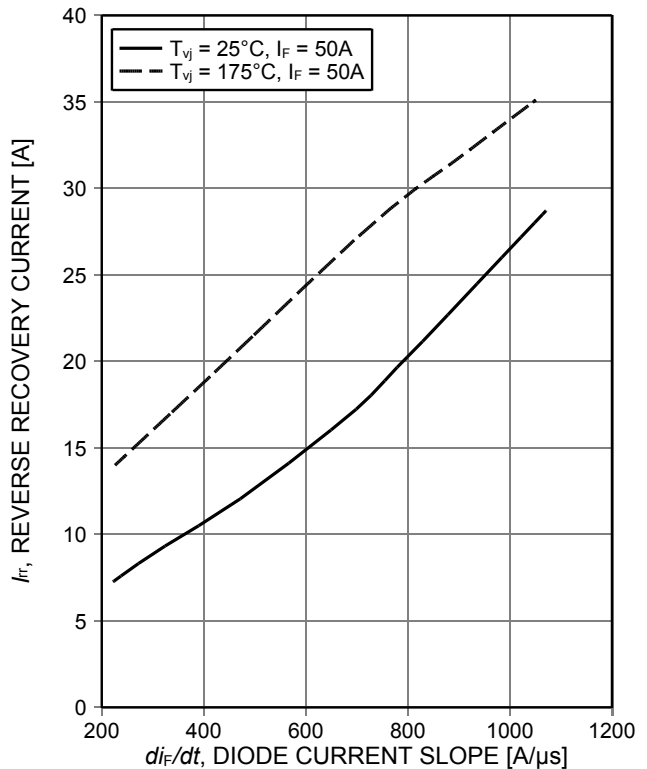


Figure 24. Typical reverse recovery current as a function of diode current slope ( $V_R=400V$ )

TRENCHSTOP™ Advanced Isolation

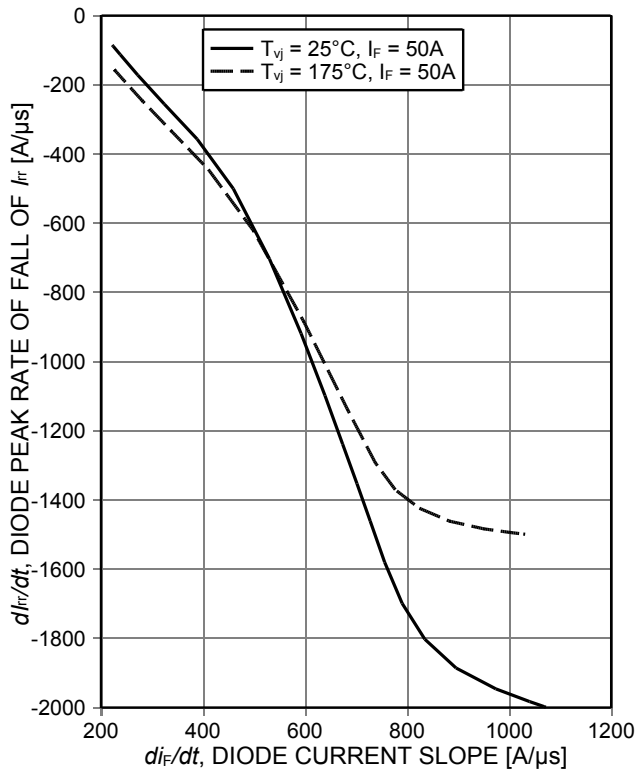


Figure 25. Typical diode peak rate of fall of reverse recovery current as a function of diode current slope ( $V_R=400V$ )

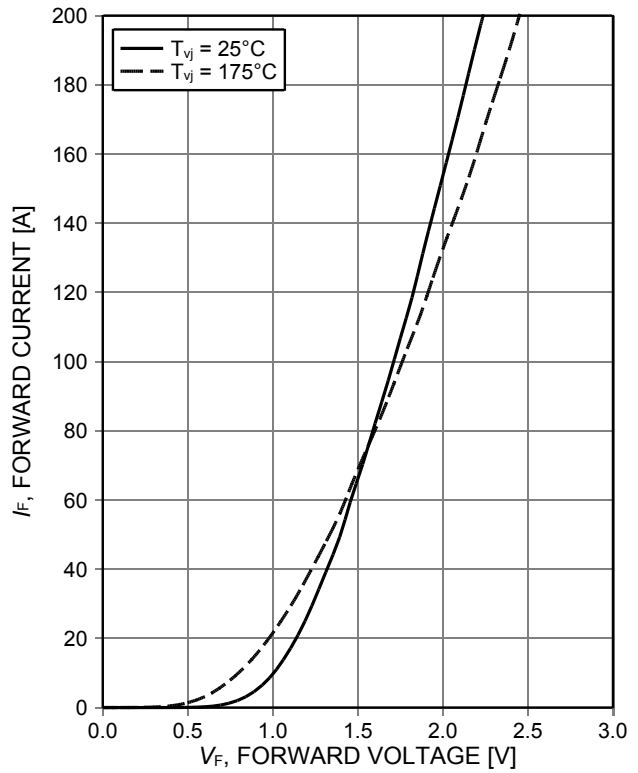


Figure 26. Typical diode forward current as a function of forward voltage

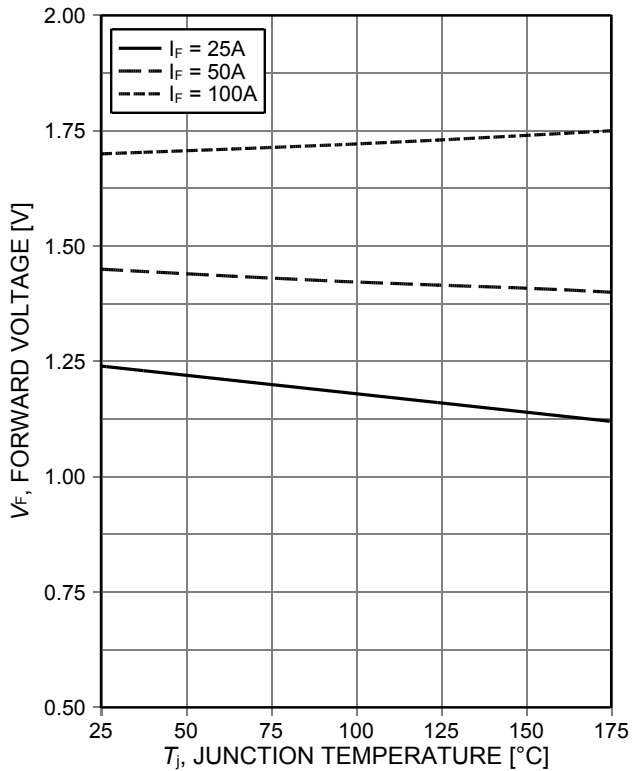
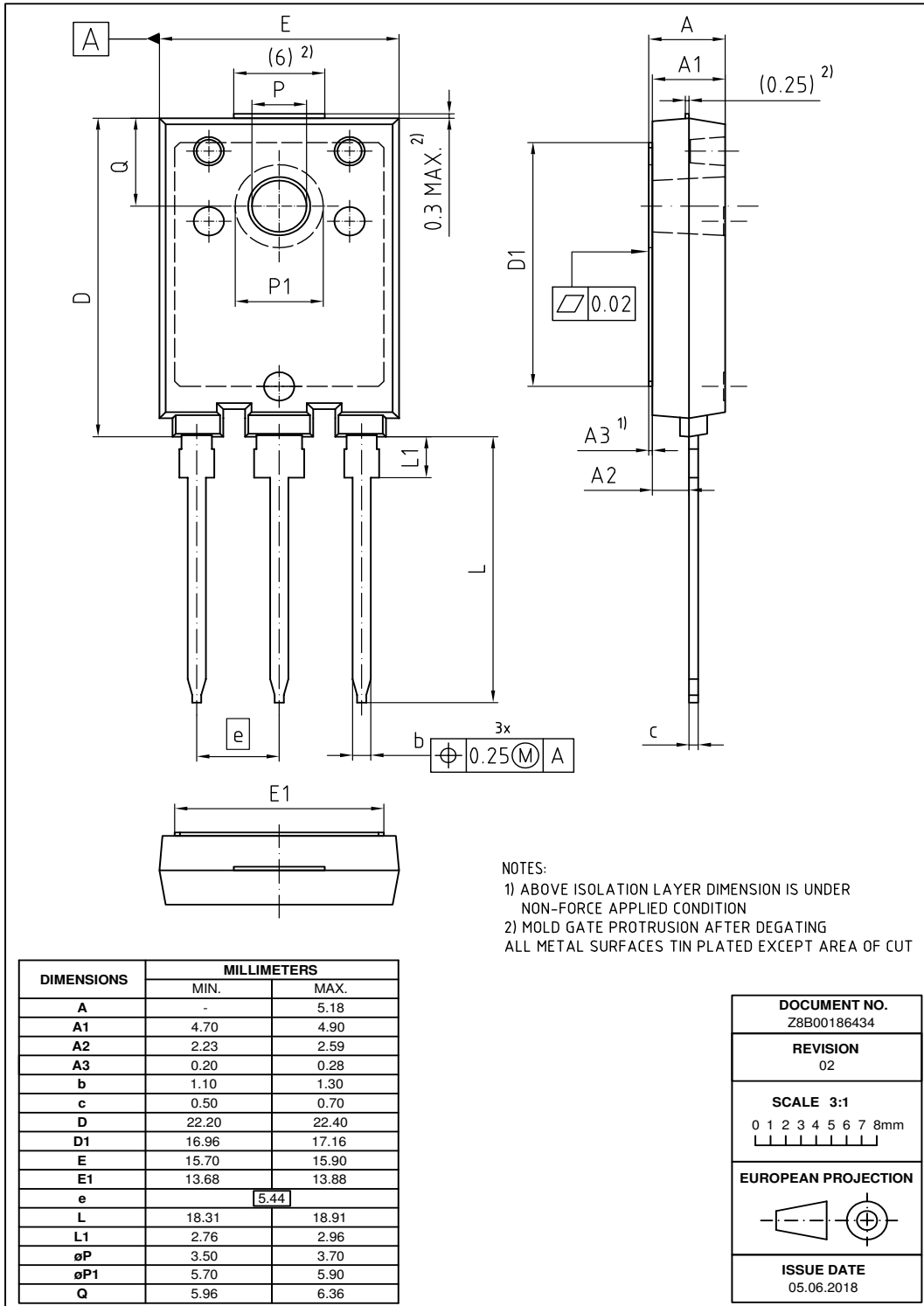


Figure 27. Typical diode forward voltage as a function of junction temperature

**PG-TO247-3-AI (PG-HSIP247-3)**



Note: For a proper handling and assembly of the advanced isolation device in the application the isolation layer must not be exposed to potential penetration via sharp implements or mechanical impacts/shocks, which exceed levels indicated in International Standard (IEC60068-2-6 and IEC60068-2-27). The advanced isolation device is intended only to be used assembled on an appropriate heatsink with recommended flatness of <20µm per 100mm and roughness of <10µm.

Testing Conditions

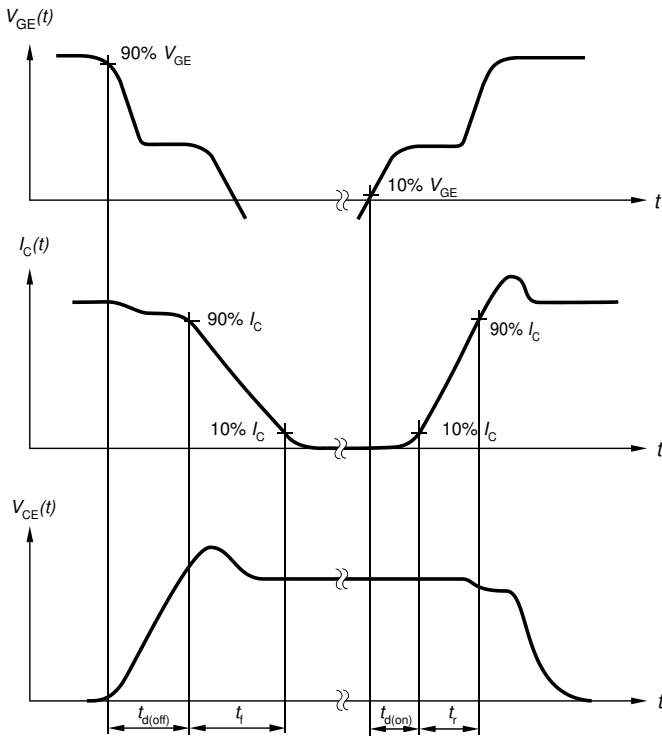


Figure A. Definition of switching times

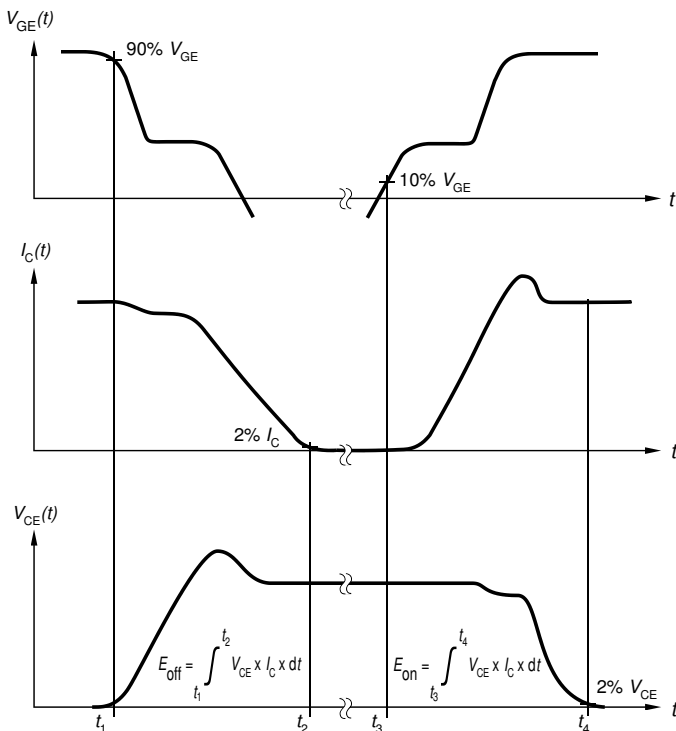


Figure B. Definition of switching losses

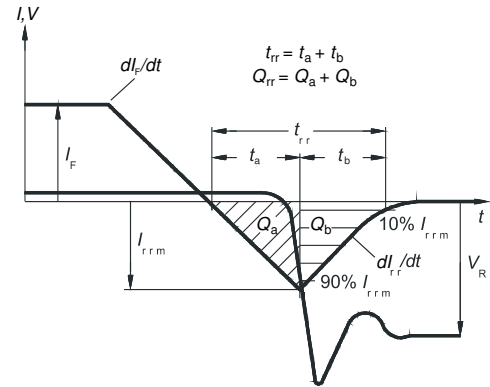


Figure C. Definition of diode switching characteristics

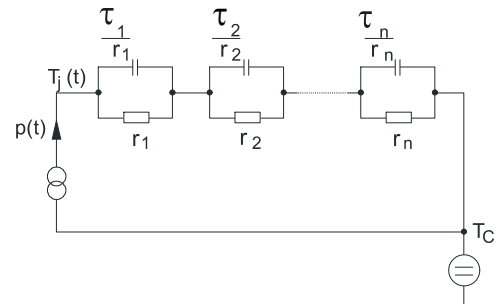


Figure D. Thermal equivalent circuit

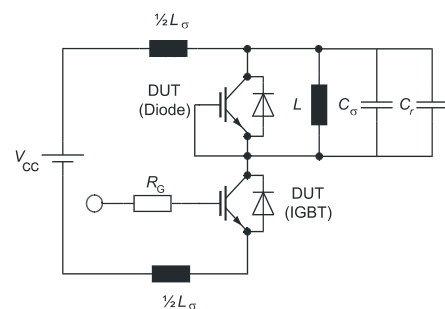


Figure E. Dynamic test circuit  
Parasitic inductance  $L_{\sigma}$ ,  
parasitic capacitor  $C_{\sigma}$ ,  
relief capacitor  $C_r$ ,  
(only for ZVT switching)

## Revision History

---

IKFW60N60EH3

**Revision: 2017-09-21, Rev. 2.1**

---

Previous Revision

---

| Revision | Date       | Subjects (major changes since last revision) |
|----------|------------|--|
| 2.1      | 2017-09-21 | Final data sheet                             |

## Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

**Published by**  
**Infineon Technologies AG**  
**81726 München, Germany**  
**© Infineon Technologies AG 2018.**  
**All Rights Reserved.**

## Important Notice

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie"). With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

For further information on the product, technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies office ([www.infineon.com](http://www.infineon.com)).

Please note that this product is not qualified according to the AEC Q100 or AEC Q101 documents of the Automotive Electronics Council.

## Warnings

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.



# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Infineon:](#)

[IKFW60N60EH3XKSA1](#)